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#### SOLUTIONS PRODUCTS DESIGN SUPPORT ABOUT CYPRESS

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## CY7C1062GN30-10BGXI





**Status: In Production** 

	Datashee	et	
English	Chinese	Japanese	

Product Specs		Packaging/Ordering	Quality and RoHS	Technical Documents
CY7C1062GN30-10BGXI				DESIGN SUPPORT
Automotive Qualified	N			
Density (Kb)	16384			Development Kits
Frequency (MHz)	N/A			Forums
Max. Operating Temp. (°C)	85			Knowledge Base
Max. Operating VCCQ (V)	3.60			Packaging
Max. Operating Voltage (V)	3.60			Product Brochures
Min. Operating Temp. (°C)	-40			
Min. Operating VCCQ (V)	2.20			Quality & Reliability
Min. Operating Voltage (V)	2.20			Samples
Organization (X x Y)	512K x 32			Technical Support
Part Family	Async Fast SRAM	Ms		Technical Training
Speed (ns)	10			Third Party Network (CYPros
Tape & Reel	N			
Temp. Classification	Industrial			

Availability	Quantity	Ships In	Buy from Cypress	Buy from Distributors
In Stock	50	24-48 hours	Contact Sales	Contact Sales

<sup>\*</sup> Prices are shown in United States dollars and are for budgetary use only for volume of 1ku

PACKAGING/ORDERING	
Package	BGA
No. of Pins	119
Package Dimensions	866 L x 2.4 H x 551 W (Mils)
Package Weight	985.75 (mgs)
Package Cross Section Drawing	Download
Package Carrier	TRAY
Package Carrier Drawing / Orientation	Drawing , Package Orientation
Standard Pack Quantity	84
Minimum Order Quantity (MOQ)	84
Order Increment	84
Estimated Lead Time (days)	91
HTS Code	8542.32.0041
ECCN	(B.2.A.)
ECCN Suball	3A991

QUALITY AND ROHS	
Moisture Sensitivity Level (MSL)	3
Peak Reflow Temp. (°C)	260 ( Cypress Reflow Profile)

### TRAINING

Workshops

Training On-Demand

Webinars

	RoHS Compliant	Y Print RoHS Certificate of Compliance
	PB Free	Υ
	Lead/Ball Finish	Sn/Ag/Cu
	Marking	Cypress Marking Format

#### **Package Material Declaration**

119 - PBGA (14 X 22 MM) PB-FREE PACKAGE MATERIAL DECLARATION DATASHEET Last Update: Nov 10, 2016

#### **IPC 1752 Material Declaration**

IPC1752 MATERIAL DECLARATION PBGA 119 (14 X 22 MM) (BG119) - ASE - NONGREEN SUBSTRATE - AU WIRE *Last Update: Oct 21, 2016* 

#### **Device Qualification Reports**

FIT/MTBF, ESD (HBM/CDM) and Latch-up data available in the Device Qualification Report.

QTP# 124902 16-mbit asynchronous sram family ull65nm (ll65up-25odr) technology, umc fab 12a.pdf *Last Update: Sep 21, 2015* 

#### **TECHNICAL DOCUMENTS**

#### Application Notes (1)

AN6081 - Interfacing 90-nm Cypress Asynchronous SRAMs in Legacy Systems Feb 18, 2018

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	Clocks & Buffers	

# CORPORATE HEADQUARTERS

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# CUSTOMER SERVICE SUPPORT

+1-800-541-4736 Hours: 8:00AM - 5:00PM (local time) Create a MyCase Cypress Developer

Community

#### **INTERNATIONAL SUPPORT**

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United States +1-800-541-4736 Hours: 4:30AM - 1:30PM (pacific time) 7:30PM - 4:30AM (standard time)

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